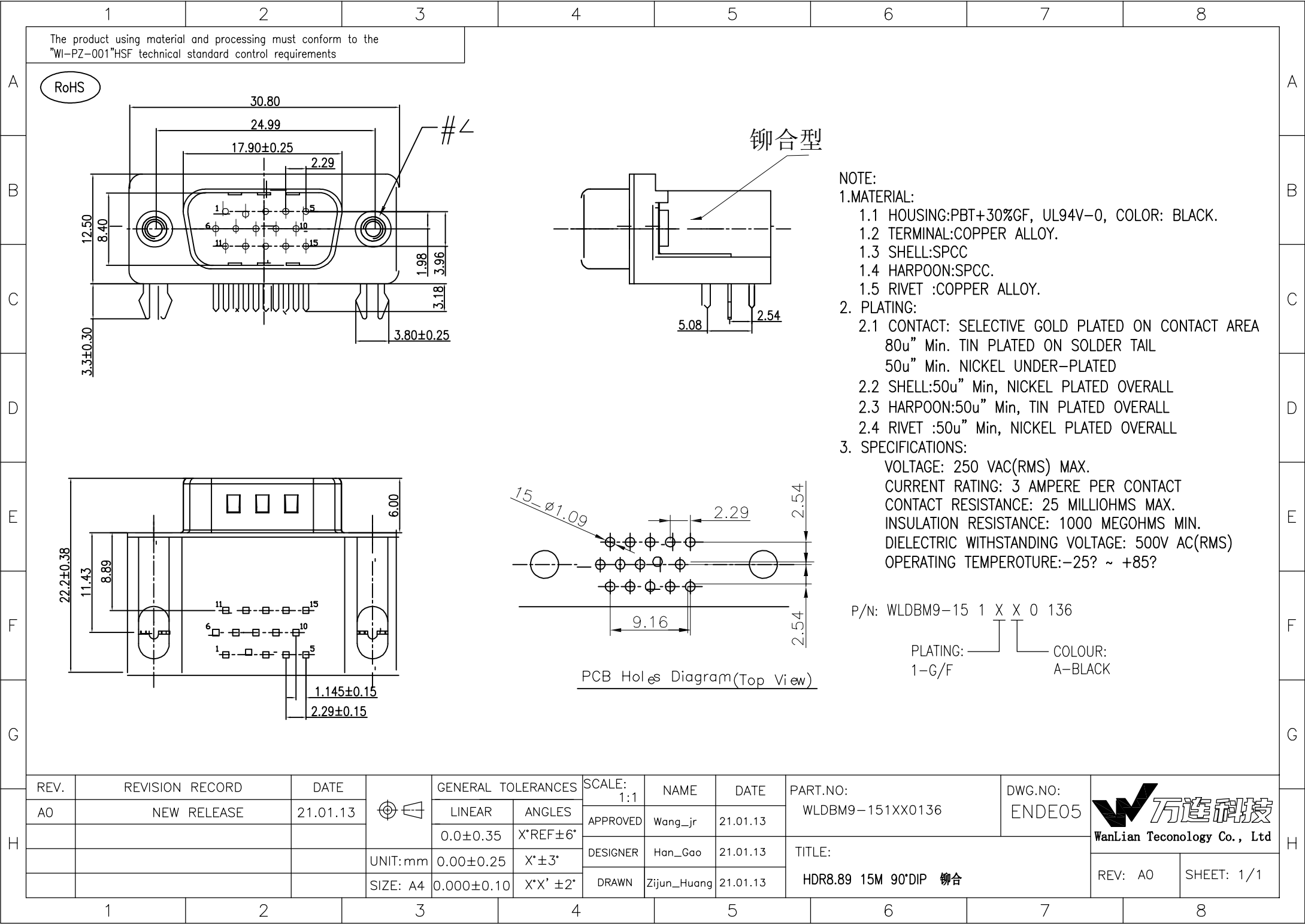




The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS

铆合型

- NOTE:
- 1.MATERIAL:
- 1.1 HOUSING:PBT+30%GF, UL94V-0, COLOR: BLACK.
 - 1.2 TERMINAL:COPPER ALLOY.
 - 1.3 SHELL:SPCC
 - 1.4 HARPOON:SPCC.
 - 1.5 RIVET :COPPER ALLOY.
2. PLATING:
- 2.1 CONTACT: SELECTIVE GOLD PLATED ON CONTACT AREA 80u" Min. TIN PLATED ON SOLDER TAIL 50u" Min. NICKEL UNDER-PLATED
 - 2.2 SHELL:50u" Min, NICKEL PLATED OVERALL
 - 2.3 HARPOON:50u" Min, TIN PLATED OVERALL
 - 2.4 RIVET :50u" Min, NICKEL PLATED OVERALL
3. SPECIFICATIONS:
- VOLTAGE: 250 VAC(RMS) MAX.
 - CURRENT RATING: 3 AMPERE PER CONTACT
 - CONTACT RESISTANCE: 25 MILLIOHMS MAX.
 - INSULATION RESISTANCE: 1000 MEGOHMS MIN.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC(RMS)
 - OPERATING TEMPERATURE:-25? ~ +85?

P/N: WLDBM9-15 1 X X 0 136

PLATING: 1-G/F COLOUR: A-BLACK

PCB Holes Diagram(Top View)

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLDBM9-151XX0136	DWG.NO: ENDE05	 WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13				
				0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	21.01.13	TITLE: HDR8.89 15M 90°DIP 铆合	REV: A0	SHEET: 1/1	
				UNIT:mm	0.00±0.25	X°±3°						
				SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	Zijun_Huang				21.01.13